SY56020R

Low Voltage 1.2V/1.8V/2.5V CML 1:4 Fanout Buffer 6.4Gbps with Equalization

General Description

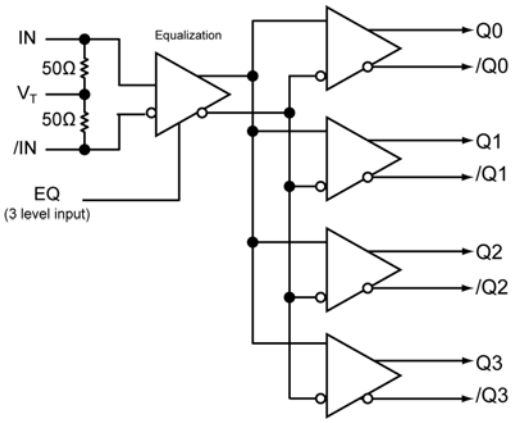
The SY56020R is a fully-differential, low-voltage 1.2V/1.8V/2.5V CML 1:4 Fanout Buffer with input equalization. The SY56020R can process clock signals as fast as 4.5GHz or data patterns up to 6.4Gbps.

The differential input includes Micrel's unique, 3-pin input termination architecture that interfaces to CML differential signals, without any level-shifting or termination resistor networks in the signal path. The differential input can also accept AC-coupled LVPECL and LVDS signals. Input voltages as small as 200mV ($400mV_{pp}$) are applied before the 9", 18" or 27" FR4 transmission line. For AC-coupled input interface applications, an internal voltage reference is provided to bias the V_T pin. The outputs are CML, with extremely fast rise/fall times guaranteed to be less than 90ps.

The SY56020R operates from a 2.5V ±5% core supply and a 1.2V, 1.8V or 2.5V ±5% output supply and is guaranteed over the full industrial temperature range (–40°C to +85°C). The SY56020R is part of Micrel's high-speed, Precision Edge® product line.

Datasheets and support documentation can be found on Micrel's web site at: www.micrel.com.

Functional Block Diagram



Precision Edge®

Features

- 1.2V/1.8V/2.5V CML 1:4 Fanout Buffer
- Equalizes 9, 18, 27 inches of FR4
- Guaranteed AC performance over temperature and voltage:
  - DC-to > 6.4Gbps Data throughput
  - DC-to > 4.5GHz Clock throughput
  - <280 ps propagation delay (IN-to-Q)
  - <15ps within-device skew
  - <90ps rise/fall times
- Ultra-low jitter design
  - $<1ps_{RMS}$ random jitter
- High-speed CML outputs
- 2.5V ±5% V_{CC} , 1.2/1.8V/2.5V ±5% V_{CCO} power supply operation
- Industrial temperature range: –40°C to +85°C
- Available in 16-pin (3mm x 3mm) QFN package

Applications

- Data distribution
- SONET clock and data distribution
- Fiber Channel clock and data distribution
- Gigabit Ethernet clock and data distribution

Markets

- Storage
- ATE
- Test and measurement
- Enterprise networking equipment
- High-end servers
- Metro area network equipment

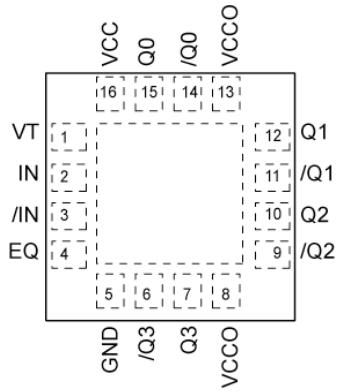
Ordering Information

Part Number	Package Type	Operating Range	Package Marking	Lead Finish
SY56020RMG	QFN-16	Industrial	R020 with Pb-Free bar-line indicator	NiPdAu Pb-Free
SY56020RMGTR[2]	QFN-16	Industrial	R020 with Pb-Free bar-line indicator	NiPdAu Pb-Free

Notes:

1. Contact factory for die availability. Dice are guaranteed at T_A = 25°C, DC Electricals only.
2. Tape and Reel.

Pin Configuration



16-Pin QFN

Truth Table

EQ	Equalization FR4 6mil Stripline
LOW	9”
FLOAT	18”
HIGH	27”

Pin Description

Pin Number	Pin Name	Pin Function
2,3	IN, /IN	Differential Input: Signals as small as 200mV V_{PK} (400mV_{PP}) applied to the input of 9, 18 or 27 inches 6mil FR4 stripline transmission line are then terminated with this differential input. Each input pin internally terminates with 50Ω to the VT pin.
1	VT	Input Termination Center-Tap: Each side of the differential input pair terminates to VT pin. This pin provides a center-tap to a termination network for maximum interface flexibility. An internal high impedance resistor divider biases VT to allow input AC-coupling. For AC-coupling, bypass VT with 0.1µF low-ESR capacitor to V_{CC}. See “Interface Applications” subsection and Figure 2a.
4	EQ	Three level input for equalization control. High, float, low.
16	VCC	Positive Power Supply: Bypass with 0.1µF//0.01µF low-ESR capacitors as close to the V_{CC} pins as possible. Supplies input and core circuitry.
8,13	VCCO	Output Supply: Bypass with 0.1µF//0.01µF low-ESR capacitors as close to the V_{CCO} pins as possible. Supplies the output buffers.
5	GND, Exposed pad	Ground: Exposed pad must be connected to a ground plane that is the same potential as the ground pins.
15,14 12,11 10,9 7,6	Q0, /Q0 Q1, /Q1 Q2, /Q2 Q3, /Q3	CML Differential Output Pairs: Differential buffered copy of the input signal. The output swing is typically 390mV. See “Interface Applications” subsection for termination information.

Absolute Maximum Ratings[1]

Supply Voltage (V_{CC}) ..... –0.5V to +3.0V
Supply Voltage (V_{CCO}) ..... –0.5V to +3.0V
$V_{CC} – V_{CCO}$ ..... <1.8V
$V_{CCO} – V_{CC}$ ..... <0.5V
Input Voltage (V_{IN}) ..... –0.5V to V_{CC}
CML Output Voltage (V_{OUT}) ..... 0.6V to 3.0V
Current (V_T)
Source or Sink on VT pin ..... ±100mA
Input Current
Source or Sink Current on (IN, /IN) ..... ±50mA
Maximum Operating Junction Temperature ..... 125°C
Lead Temperature (soldering, 20sec.) ..... 260°C
Storage Temperature (T_s) ..... –65°C to +150°C

Operating Ratings[2]

Supply Voltage (V_{cc}) ..... 2.375V to 2.625V
(V_{cco}) ..... 1.14V to 2.625V
Ambient Temperature (T_A) ..... –40°C to +85°C
Package Thermal Resistance[3]
QFN
Still-Air (θ_{JA}) ..... 75°C/W
Junction-to-Board (ψ_{JB}) ..... 33°C/W

DC Electrical Characteristics[4]

T_A = –40°C to +85°C, unless otherwise stated.

Symbol	Parameter	Condition	Min.	Typ.	Max.	Units
V_{CC}	Power Supply Voltage Range	V_{CC} V_{CCO} V_{CCO} V_{CCO}	2.375 1.14 1.7 2.375	2.5 1.2 1.8 2.5	2.625 1.26 1.9 2.625	V
I_{CC}	Power Supply Current	Maximum V_{CC}.		60	85	mA
I_{CCO}	Power Supply Current	No Load. Maximum V_{CCO}.		64	84	mA
R_{IN}	Input Resistance (IN-to-V_T, /IN-to-V_T)		45	50	55	Ω
R_{DIFF_IN}	Differential Input Resistance (IN-to-/IN)		90	100	110	Ω
V_{IH}	Input HIGH Voltage (IN, /IN)	IN, /IN	1.42		V_{CC}	V
V_{IL}	Input LOW Voltage (IN, /IN)	IN, /IN 1.22V = 1.7-0.475	1.22		V_{IH}–0.2	V
V_{IN}	Input Voltage Swing (IN, /IN)	See Figure 3a, applied to input of transmission line.	0.2		1.0	V
V_{DIFF_IN}	Differential Input Voltage Swing (|IN – /IN|)	See Figure 3b, applied to input of transmission line.	0.4		2.0	V
V_{T_IN}	Voltage from Input to V_T				1.28	V

Notes:

1. Permanent device damage may occur if absolute maximum ratings are exceeded. This is a stress rating only and functional operation is not implied at conditions other than those detailed in the operational sections of this data sheet. Exposure to absolute maximum ratings conditions for extended periods may affect device reliability.
2. The data sheet limits are not guaranteed if the device is operated beyond the operating ratings.
3. Package thermal resistance assumes exposed pad is soldered (or equivalent) to the device's most negative potential on the PCB. ψ_{JB} and θ_{JA} values are determined for a 4-layer board in still-air number, unless otherwise stated.
4. The circuit is designed to meet the DC specifications shown in the above table after thermal equilibrium has been established.

CML Outputs DC Electrical Characteristics[5]

V_{CCO} = 1.14V to 1.26V R_L = 50Ω to V_{CCO},
V_{CCO} = 1.7V to 1.9V, 2.375V to 2.625V, R_L = 50Ω to V_{CCO} or 100Ω across the outputs.
V_{CC} = 2.375V to 2.625V; T_A = –40°C to +85°C, unless otherwise stated.

Symbol	Parameter	Condition	Min.	Typ.	Max.	Units
V_{OH}	Output HIGH Voltage	R_L = 50Ω to V_{CCO}	V_{CC} – 0.020	V_{CC} – 0.010	V_{CC}	V
V_{OUT}	Output Voltage Swing	See Figure 3a	300	390	475	mV
V_{DIFF_OUT}	Differential Output Voltage Swing	See Figure 3b	600	780	950	mV
R_{OUT}	Output Source Impedance		45	50	55	Ω

Three Level EQ Input DC Electrical Characteristics[5]

V_{CC} = 2.375V to 2.625V; T_A = –40°C to +85°C, unless otherwise stated.

Symbol	Parameter	Condition	Min.	Typ.	Max.	Units
V_{IH}	Input HIGH Voltage		V_{CC} – 0.3		V_{CC}	V
V_{IL}	Input LOW Voltage		0		V_{EE} + 0.3	V
I_{IH}	Input HIGH Current	V_{IH} = V_{CC}			400	µA
I_{IL}	Input LOW Current	V_{IL} = GND	–480			µA

Note:

5. The circuit is designed to meet the DC specifications shown in the above table after thermal equilibrium has been established.

AC Electrical Characteristics

V_{CCO} = 1.14V to 1.26V R_L = 50Ω to V_{CCO},
V_{CCO} = 1.7V to 1.9V, 2.375V to 2.625V, R_L = 50Ω to V_{CCO} or 100Ω across the outputs,
V_{CC} = 2.375V to 2.625V; T_A = –40°C to +85°C, unless otherwise stated.

Symbol	Parameter	Condition	Min.	Typ.	Max.	Units
f_{MAX}	Maximum Frequency	NRZ Data	6.4			Gbps
		V_{OUT} > 200mV Clock	4.5			GHz
t_{PD}	Propagation Delay IN-to-Q	Note 6, Figure 1	100	180	280	ps
t_{Skew}	Output-to-Output Skew	Note 7		3	15	ps
	Part-to-Part Skew	Note 8			100	ps
t_{Jitter}	Random Jitter	Note 9			1	ps_{RMS}
t_r t_f	Output Rise/Fall Time (20% to 80%)	At full output swing.	20	50	90	ps

Notes:

6. Propagation delay is measured with no attenuating transmission line connected to the input.
7. Output-to-Output skew is the difference in time between both outputs, receiving data from the same input, for the same temperature, voltage and transition.
8. Part-to-part skew is defined for two parts with identical power supply voltages at the same temperature and no skew at the edges at the respective inputs.
9. Random jitter is measured with a K28.7 pattern, measured at ≤ f_{MAX}.

Interface Applications

For Input Interface Applications see Figures 4a-e and for CML Output Termination, see Figures 5a-d.

CML Output Termination with VCCO 1.2V

For VCCO of 1.2V, Figure 5a, terminate the output with 50Ω to 1.2V, DC coupled, not 100Ω differentially across the outputs.

If AC-coupling is used, Figure 5d, terminate into 50Ω to 1.2V before the coupling capacitor and then connect to a high value resistor to a reference voltage.

Do not AC-couple with internally terminated receiver. For example, 50Ω ANY-IN input. AC-coupling will offset the output voltage by 200mV and this offset voltage will be too low for proper driver operation. Any unused output pair needs to be terminated when VCCO is 1.2V, do not leave floating.

CML Output Termination with VCCO 1.8V, 2.5V

For VCCO of 1.8V, Figure 5a and Figure 5b, terminate either with 50 ohms to VCCO or 100 ohms differentially across the outputs. AC- or DC-coupling is fine. For best signal integrity, terminate any unused output pairs.

Input Termination

From 1.8V CML driver: Terminate input with VT tied to 1.8V. Don't terminate 100 ohms differentially.

From 2.5V CML driver: Terminate input with either VT tied to 2.5V or 100 ohms differentially.

The input cannot be DC-coupled from a 1.2V CML driver.

Input AC-Coupling

The SY56020R input can accept AC-coupling from any driver. Bypass VT with a 0.1µF low-ESR capacitor to VCC as shown in Figures 4c and 4d. VT has an internal high impedance resistor divider as shown in Figure 2a, to provide a bias voltage for AC-coupling.

Timing Diagrams

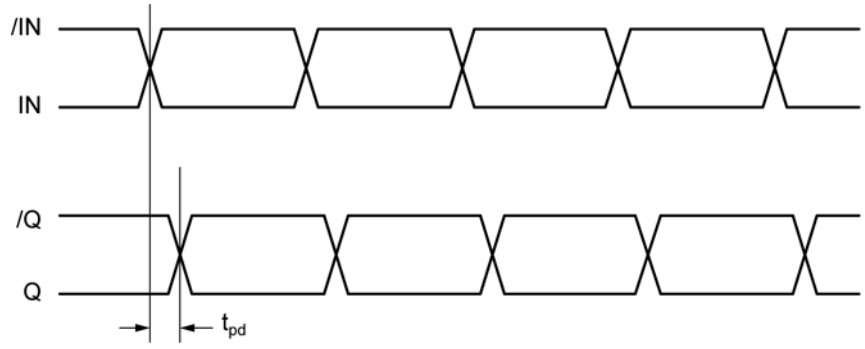


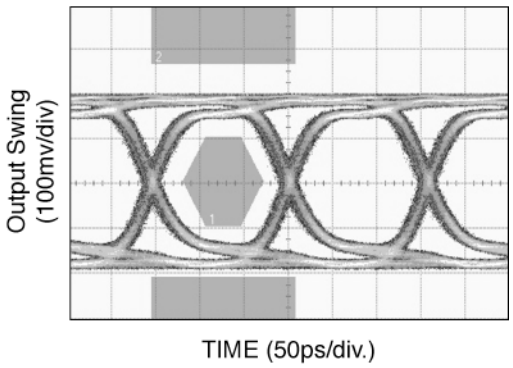
Figure 1. Propagation Delay

Figure 1. Propagation Delay

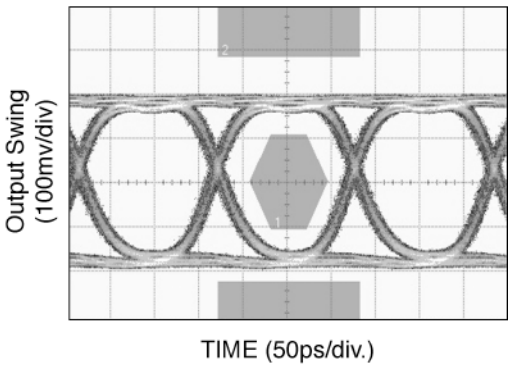
Typical Characteristics

V_{CC} = 2.5, V_{CCO} = 1.2V, GND = 0V, V_{IN} = 400mV, R_L = 50Ω to 1.2V, Data Pattern: 2^{23}-1, T_A = 25°C, unless otherwise stated.

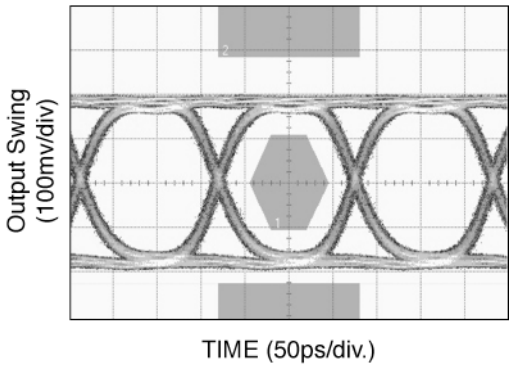
6.4Gbps, 24 inch FR4



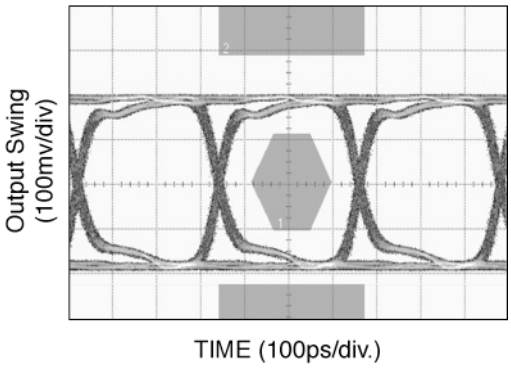
6.4Gbps, 18 inch FR4



6.4Gbps, 9 inch FR4



3.2Gbps, 24 inch FR4



Input and Output Stage

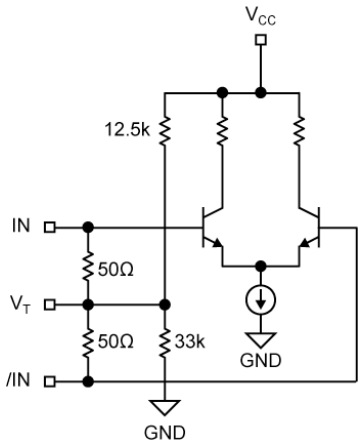


Figure 2a. Simplified Differential Input Buffer

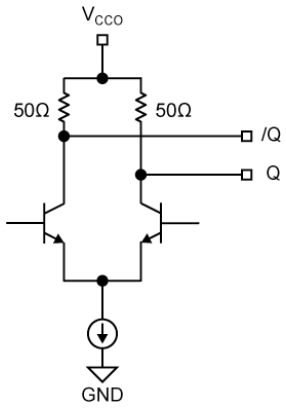


Figure 2b. Simplified CML Output Buffer

Single-Ended and Differential Swings

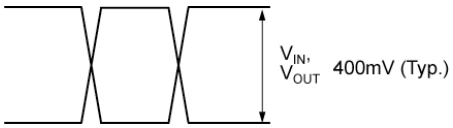


Figure 3a. Single-Ended Swing

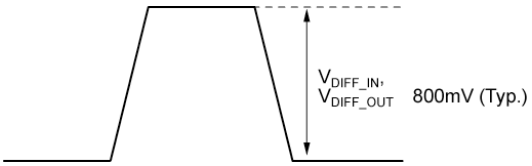


Figure 3b. Differential Swing

Input Interface Applications

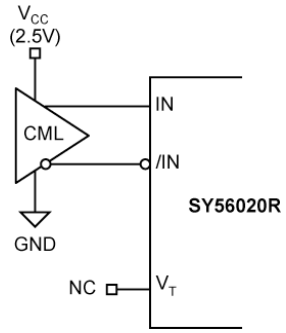


Figure 4a. CML Interface (DC-Coupled, 1.8V, 2.5V)
Option: May connect V_T to V_{CC}

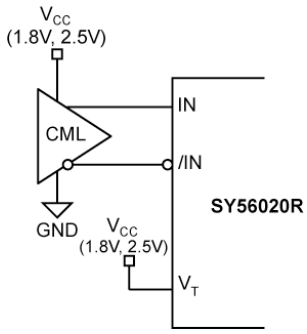


Figure 4b. CML Interface (DC-Coupled, 1.8V, 2.5V)

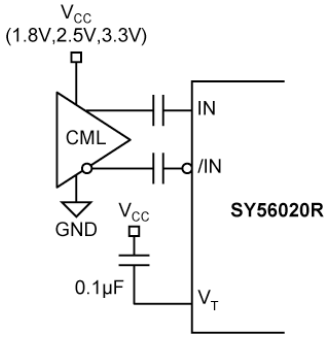


Figure 4c. CML Interface (AC-Coupled)

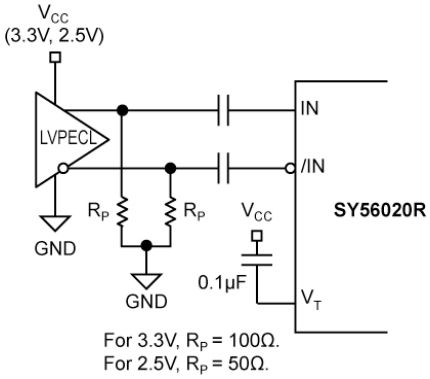


Figure 4d. LVPECL Interface (AC-Coupled)

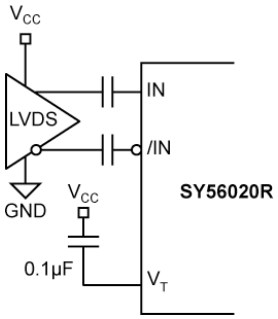


Figure 4e. LVPECL Interface (DC-Coupled)

hbwhelp@micrel.com or (408) 955-1690

CML Output Termination

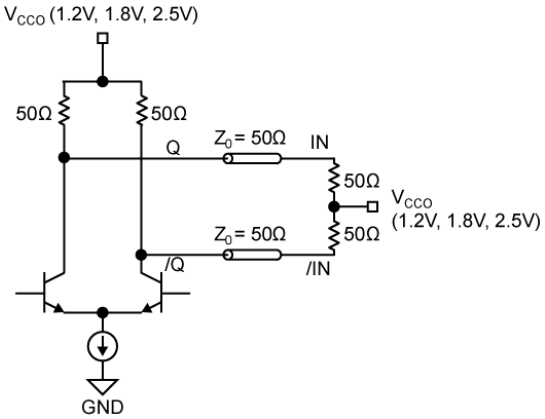


Figure 5a. 1.2V, 1.8V or 2.5V CML DC-Coupled Termination

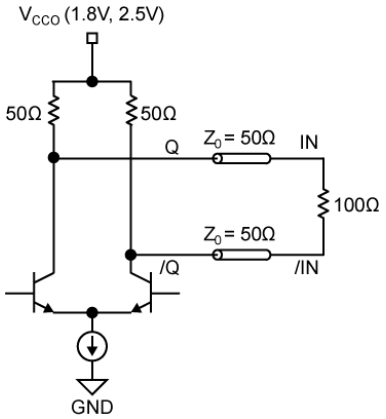


Figure 5b. 1.8V or 2.5V CML DC-Coupled Termination

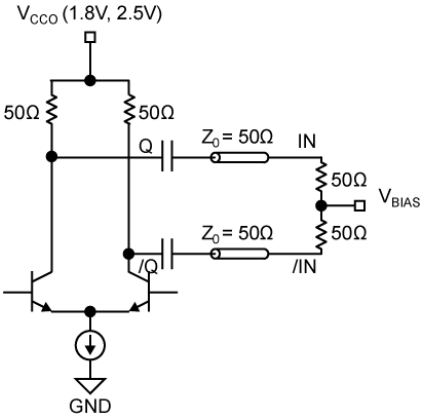


Figure 5c. CML AC-Coupled Termination (V_{CCO} 1.8V or 2.5V)

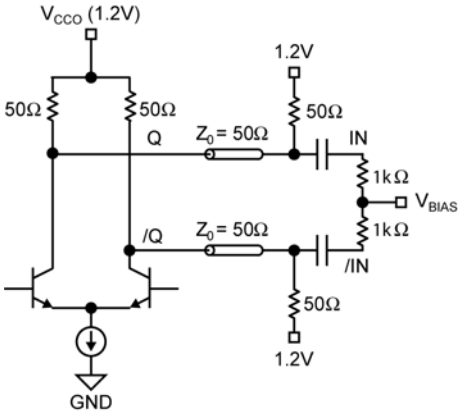
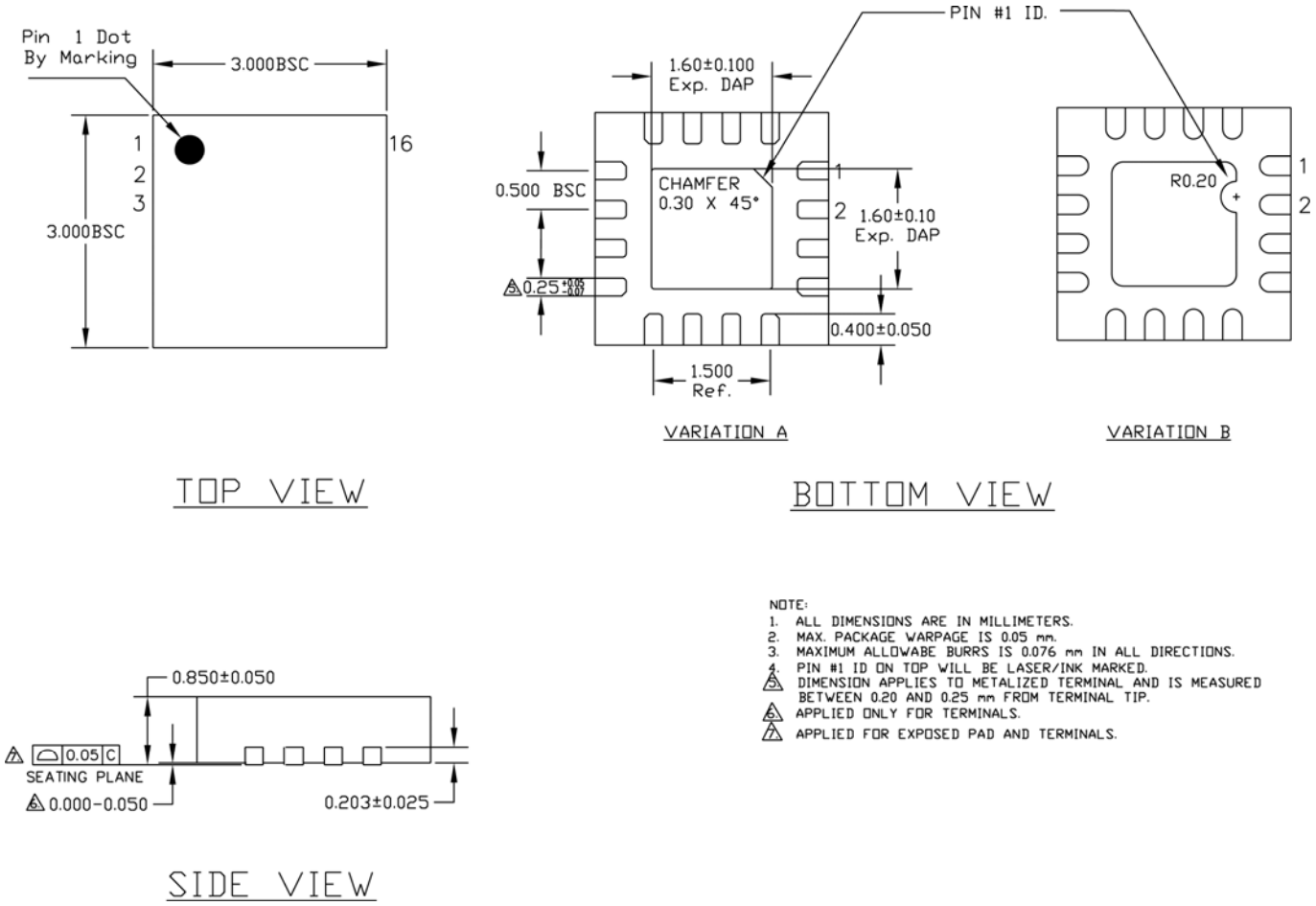


Figure 5d. CML AC-Coupled Termination (V_{CCO} 1.2V only)

Related Product and Support Documents

Part Number	Function	Datasheet Link
HBW Solutions	New Products and Termination Application Notes	http://www.micrel.com/page.do?page=/product-info/as/HBWsolutions.shtml

Package Information



16-Pin QFN

MICREL, INC. 2180 FORTUNE DRIVE SAN JOSE, CA 95131 USA
TEL +1 (408) 944-0800 FAX +1 (408) 474-1000 WEB http://www.micrel.com

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